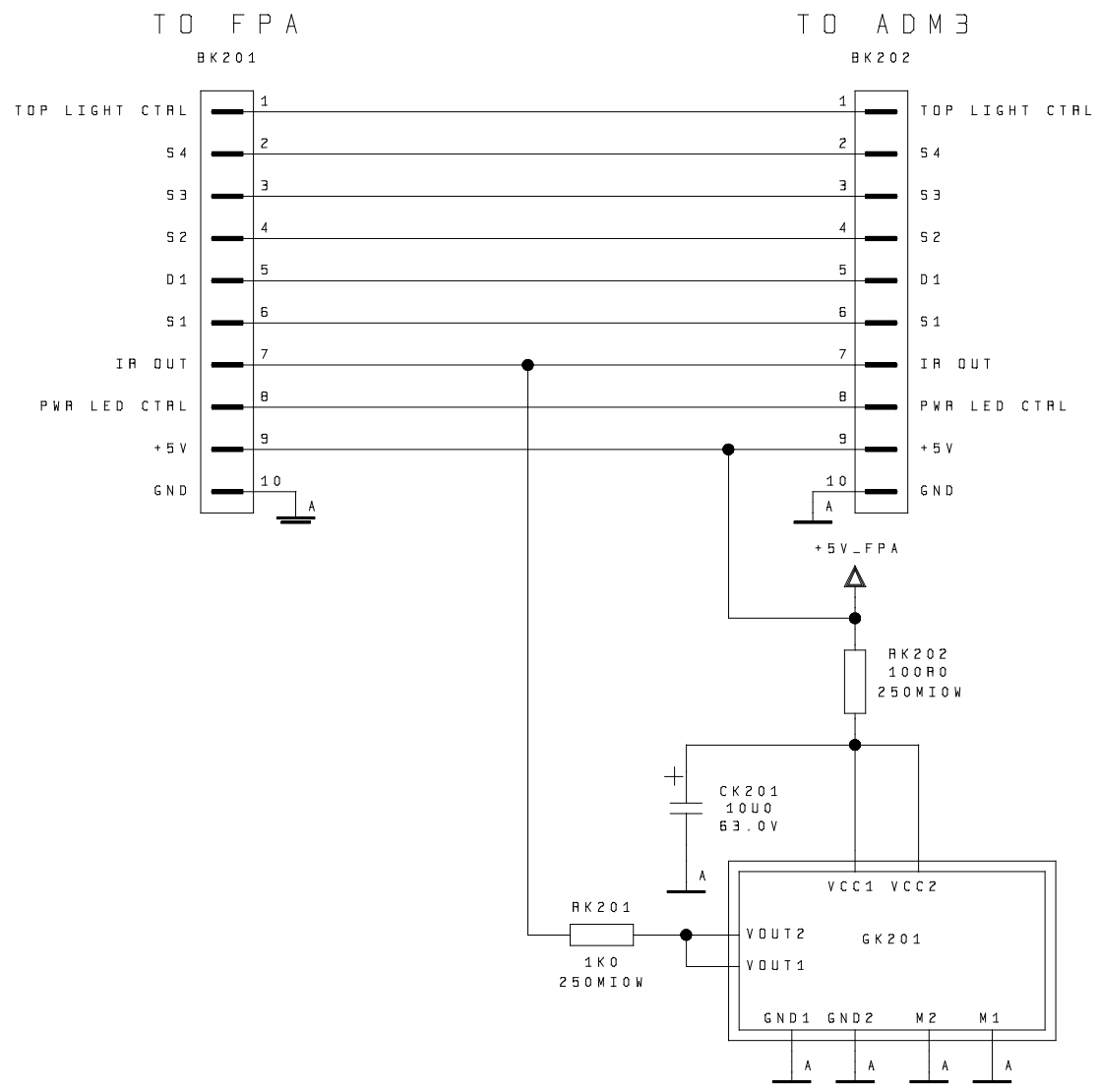
ATC351 IR SCHEMATIC

461 462 463 464 465 466 467 468 469 470 471 472 473 474 475 476 477 478 479 480

A B C D E F G H I J K L



SCHEMATIC NOTES

1. RESISTANCE VALUES ARE IN OHMS; K=X1000, Meg=X1,000,000.
   RESISTORS ARE 0.250W OR LESS 5%, EXCEPT WHERE INDICATED.
   [ ] INDICATES FLAT MAXI-CHIP COMPONENT, 1/8W EXCEPT WHERE INDICATED.
   / \ INDICATES FLAT MINI-CHIP COMPONENT, 1/16W EXCEPT WHERE INDICATED.
2. CAPACITANCE VALUES 1.0 AND ABOVE ARE IN pF, VALUES BELOW 1.0 ARE IN µF
   EXCEPT WHERE INDICATED. VOLTAGE RATING IS 50V EXCEPT WHERE INDICATED.
   [ ] INDICATES FLAT MAXI-CHIP COMPONENT.
   / \ INDICATES FLAT MINI-CHIP COMPONENT.
   \ / INDICATES FLAT MINI-CHIP COMPONENT.
3. ⏚ DENOTES CHASSIS GROUND. ⊕ INDICATES CONNECTION VIA POINT-TO-POINT WIRE.
   ⏚ DENOTES ISOLATED GROUND.
   ⌒ —INDICATES JUMPER WIRE.
   —o o— INDICATES ZERO OHM CHIP COMPONENT.

VOLTAGES IN ( ) MEASURED IN ECO OR STANDBY MODE

ALL INTEGRATED CIRCUITS AND MANY OTHER SEMICONDUCTORS ARE ELECTROSTATICALLY SENSITIVE AND REQUIRE SPECIAL HANDLING TECHNIQUES DESCRIBED UNDER "ELECTROSTATICALLY SENSITIVE (ES) DEVICES" IN THE SAFETY AND SERVICING PRECAUTIONS PUBLICATION.

PRODUCT SAFETY NOTE

COMPONENTS WITH A ⚠ HAVE SPECIAL CHARACTERISTICS IMPORTANT TO SAFETY. BEFORE REPLACING ANY OF THESE COMPONENTS READ CAREFULLY THE PRODUCT SAFETY NOTICE IN THIS SERVICE DATA. DO NOT DEGRADE THE SAFETY OF THE SET THROUGH IMPROPER SERVICING.

08/13/01 07:21 DATE

Page 9–24